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Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Not recommended
for new design

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2SC458, 2SC2308

Silicon NPN Epitaxial

REJ03G0681-0200
 (Previous ADE-208-1043)
 Rev.2.00
 Aug.10.2005

Application

- Low frequency amplifier
- Complementary pair with 2SA1029 and 2SA1030

Outline

RENESAS Package code: PRSS0003DA-A
 (Package name: TO-92 (1))



1. Emitter
2. Collector
3. Base

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	2SC458	2SC2308	Unit
Collector to base voltage	V_{CBO}	30	55	V
Collector to emitter voltage	V_{CEO}	30	50	V
Emitter to base voltage	V_{EBO}	5	5	V
Collector current	I_C	100	100	mA
Emitter current	I_E	-100	-100	mA
Collector power dissipation	P_C	200	200	mW
Junction temperature	T_j	150	150	°C
Storage temperature	T_{stg}	-55 to +150	-55 to +150	°C

Electrical Characteristics

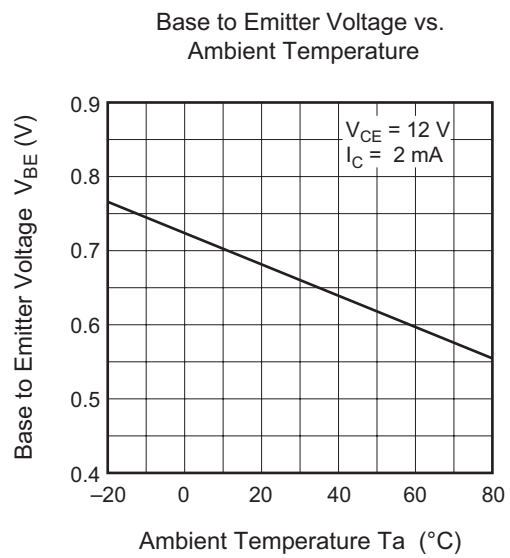
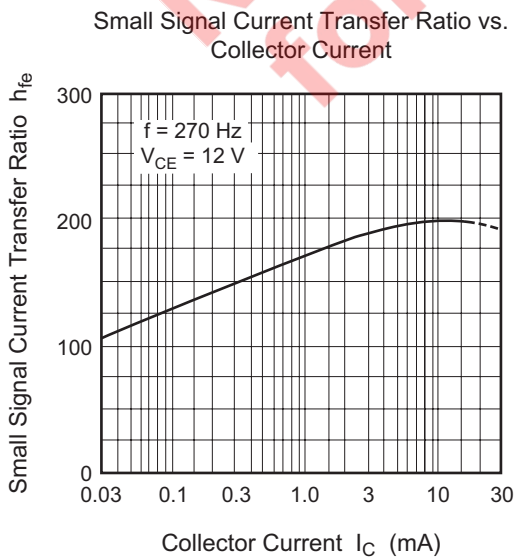
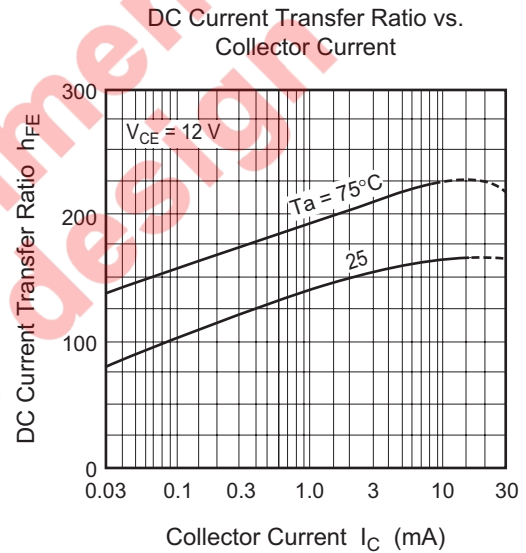
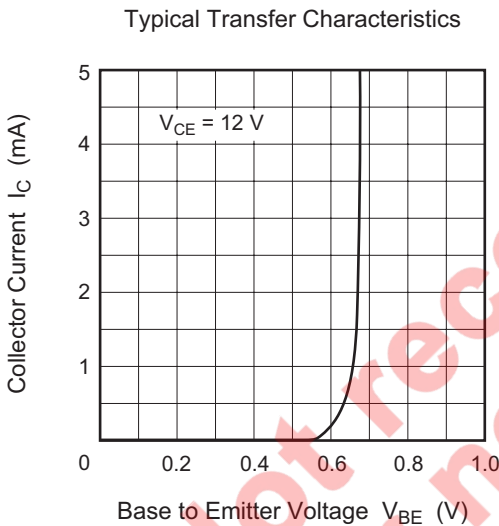
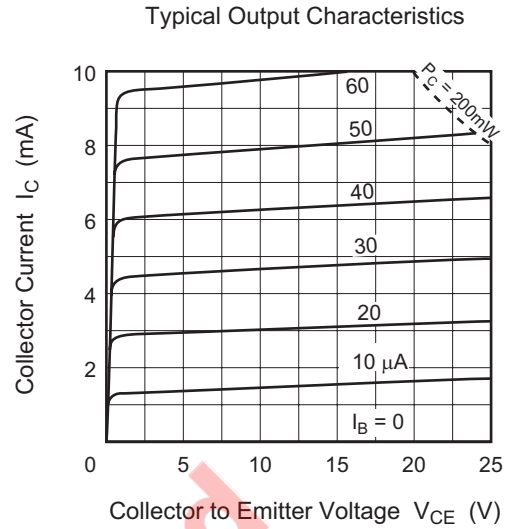
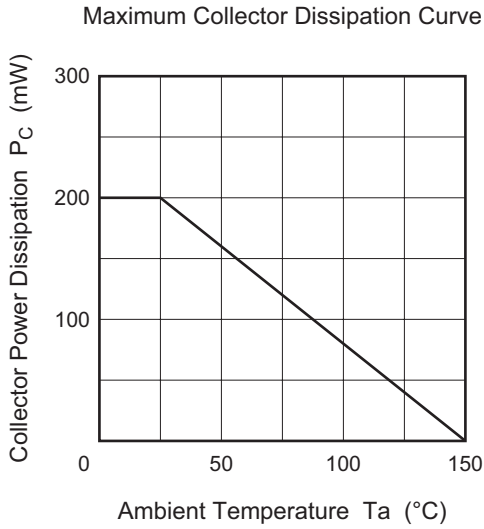
(Ta = 25°C)

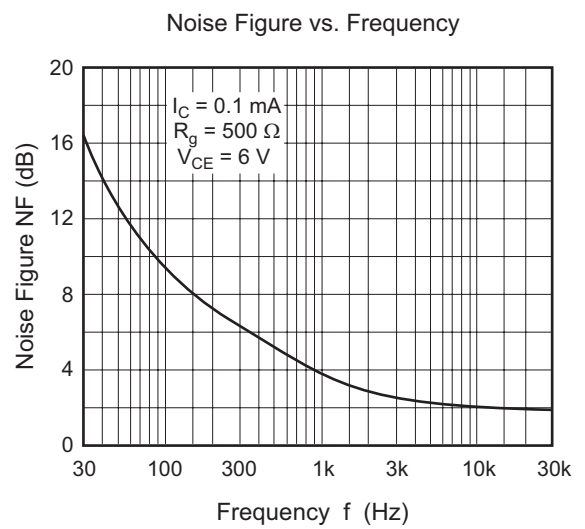
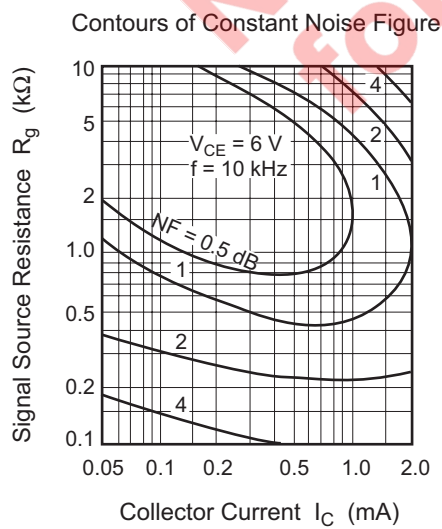
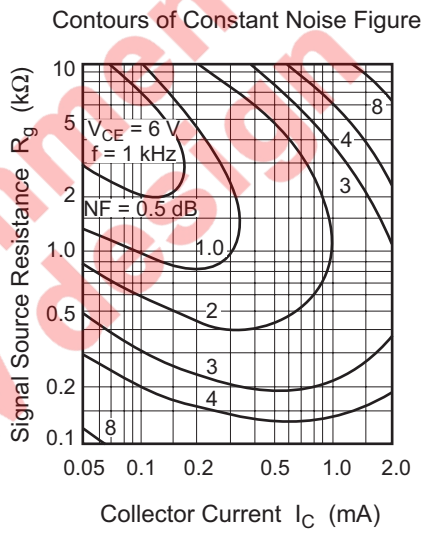
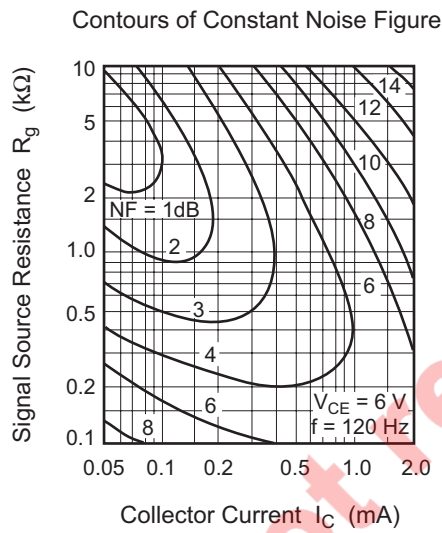
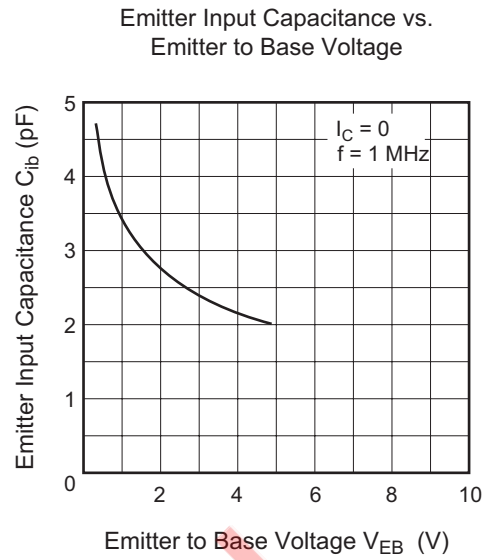
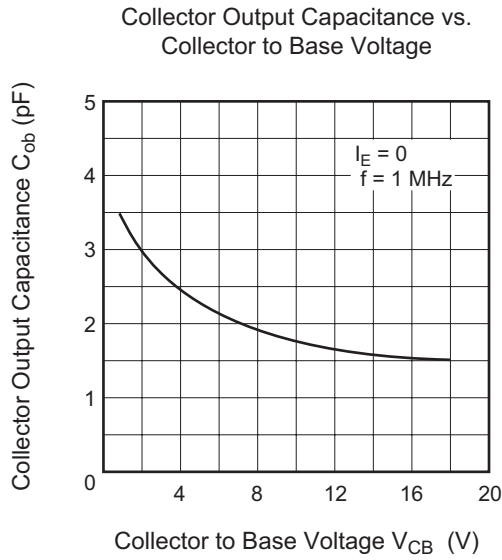
Item	Symbol	2SC458			2SC2308			Unit	Test conditions
		Min	Typ	Max	Min	Typ	Max		
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	—	—	55	—	—	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	30	—	—	50	—	—	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	—	—	5	—	—	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	I_{CBO}	—	—	0.5	—	—	0.5	μA	$V_{CB} = 18 \text{ V}, I_E = 0$
Emitter cutoff current	I_{EBO}	—	—	0.5	—	—	0.5	μA	$V_{EB} = 2 \text{ V}, I_C = 0$
DC current transfer ratio	h_{FE}^{*1}	100	—	500	160	—	320		$V_{CE} = 12 \text{ V}, I_C = 2 \text{ mA}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	0.2	—	—	0.2	V	$I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$
Base to emitter voltage	V_{BE}	—	0.67	0.75	—	0.67	0.75	V	$V_{CE} = 12 \text{ V}, I_C = 2 \text{ mA}$
Gain bandwidth product	f_T	—	230	—	—	230	—	MHz	$V_{CE} = 12 \text{ V}, I_C = 2 \text{ mA}$
Collector output capacitance	C_{ob}	—	1.8	3.5	—	1.8	3.5	pF	$V_{CB} = 10 \text{ V}, I_E = 0,$ $f = 1 \text{ MHz}$
Noise figure	NF	—	4	10	—	4	10	dB	$V_{CE} = 6 \text{ V}, I_C = 0.1 \text{ mA},$ $f = 1 \text{ kHz}, R_g = 500 \Omega$
Small signal input impedance	h_{ie}	—	16.5	—	—	16.5	—	k Ω	$V_{CE} = 5 \text{ V}, I_C = 0.1 \text{ mA},$ $f = 270 \text{ Hz}$
Small signal voltage feedback ratio	h_{re}	—	70	—	—	70	—	$\times 10^{-6}$	
Small signal current transfer ratio	h_{fe}	—	130	—	—	130	—		
Small signal output admittance	h_{oe}	—	11.0	—	—	11.0	—	μS	

Note: 1. The 2SC458 is grouped by h_{FE} as follows.

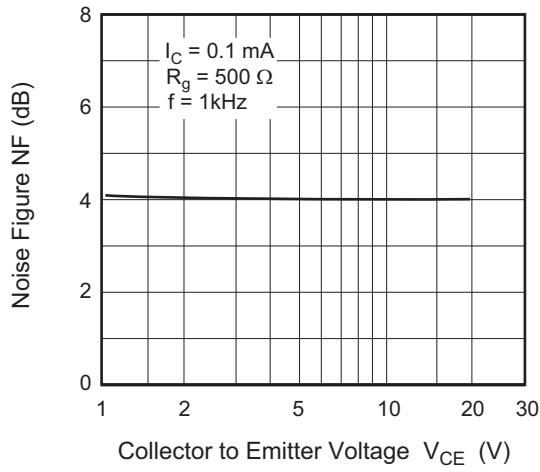
	B	C	D
2SC458	100 to 200	160 to 320	250 to 500

Main Characteristics

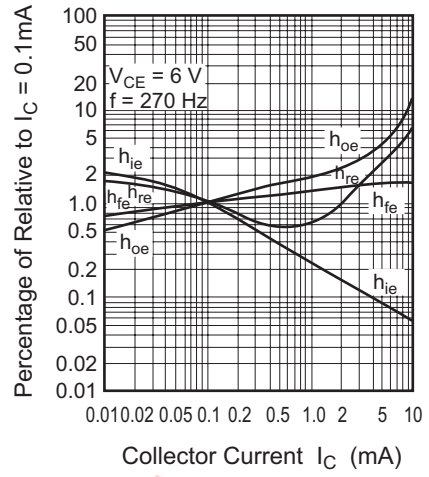




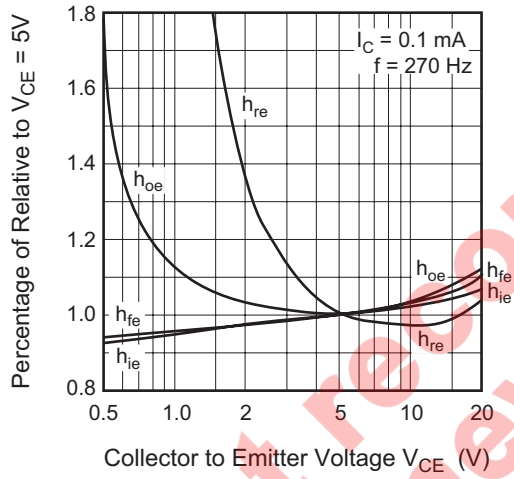
Noise Figure vs. Collector to Emitter Voltage



h Parameter vs. Collector Current

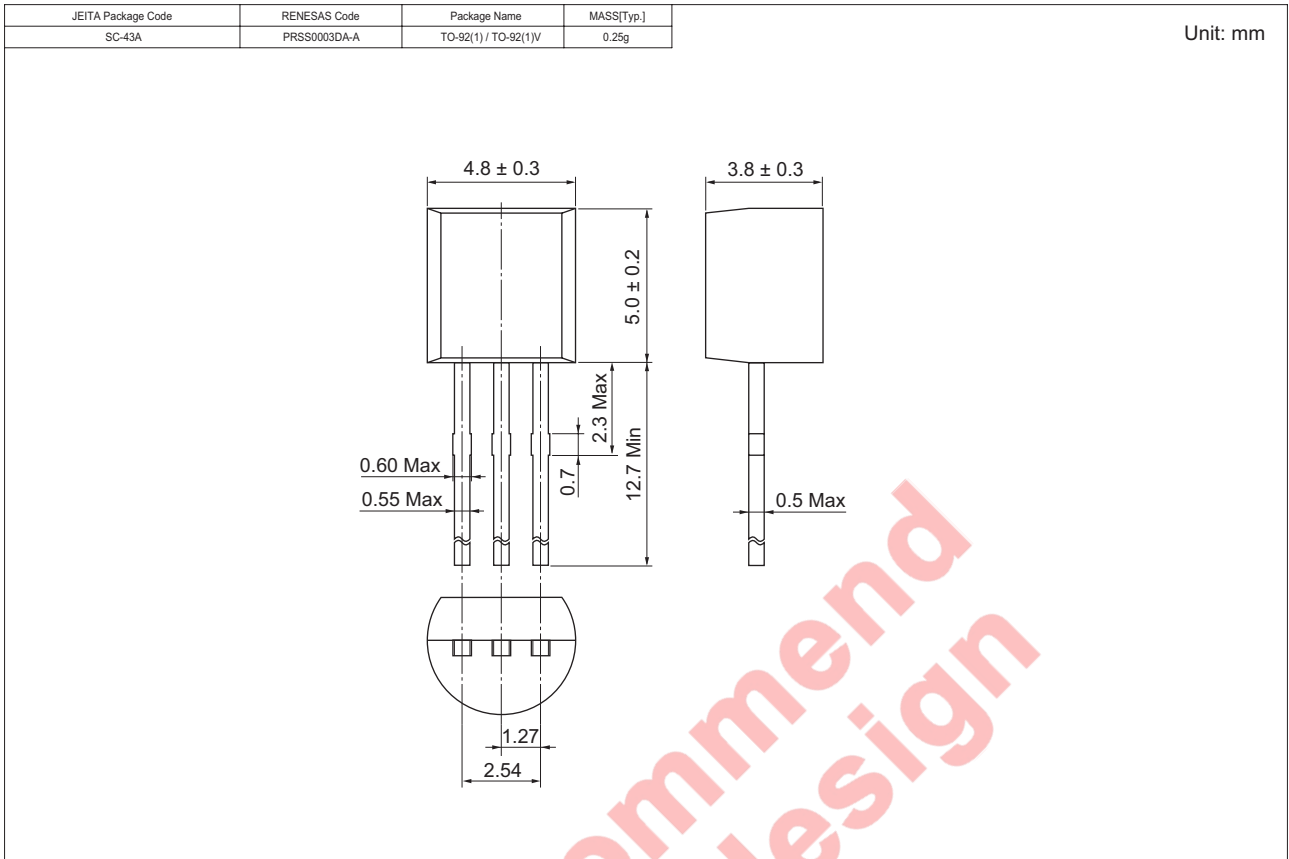


h Parameter vs. Collector to Emitter Voltage



Not recommended for new design

Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SC458BTZ 2SC458CTZ 2SC458DTZ 2SC2308CTZ	2500	Hold Box, Radial Taping

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